AN7130

4.2W Audio Power Amplifier

■ Description

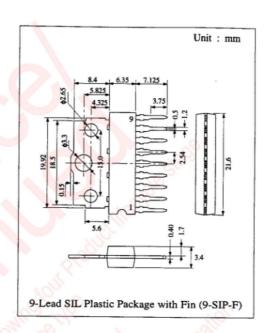
The AN7130 is a monolithic integrated circuit designed for audio high power amplifiers in consumer applications. It is also suitable for portable radios and cassette recorders.

Features

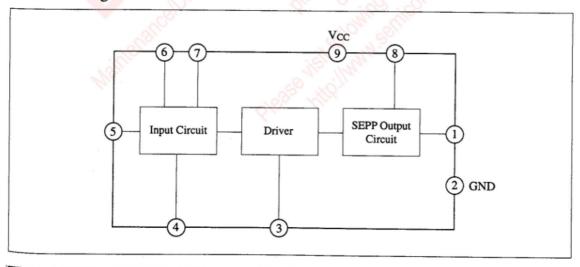
- High maximum output power: $P_O = 4.2W$ at $V_{CC} = 13.2V$, $R_L = 4\Omega$
- Low quiescent current: I_{CQ} = 20mA at V_{CC} = 13.2V

Pin

Pin No.	Pin Name
1	Output
2	GND
3	Phase Compensation
4	N.F.B.
5	Input
6	Ripple Filter
7	Ripple Filter
8	Bootstrap
9	V _{CC}



Block Diagram



Panasonic

■ Absolute Maximum Ratings (Ta=25°C)

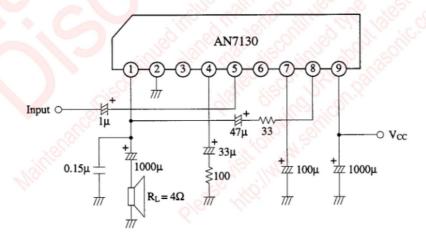
Item	Symbol	Rating	Unit	
Supply Voltage	V _{cc}	18		
Supply Current	Icc	3	A	
Power Dissipation	P _D	10	w	
Operating Ambient Temperature	Topr	-30 ~ +75	°C	
Storage Temperature	Tstg	-40 ~ +150	°C	

Operating Supply Voltage Range: $V_{CC} = 4.0V \sim 18.0V$

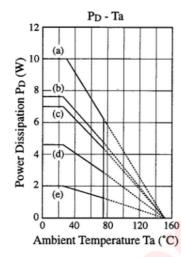
■ Electrical Characteristics (V_{CC}=13.2V, R_L=4Ω, f=1kHz, Ta=25±2°C)

Item	Symbol	Condition	min.	typ.	max.	Unit
Quiescent Current	Icq	$V_{in} = 0mV$	10	20	50	mA
Voltage Gain	Gv	$V_{in} = 5mV$	43	46	49	dB
Output Power	Po	THD = 10%	3.7	4.2		w
Total Harmonic Distortion	THD	V _{in} = 5mV	0	0.4	1.5	%
Output Noise Voltage	V _{no}	$R_g = 10k\Omega$		0.5	1.2	mV
Input Impedance	Zin			25		kΩ

Application Circuit



■ Characteristics Curve



- Infinite heat sink
 100cm² x 3mm Al (black colour
 coated) or a 200cm² x 2mm Al (not
 lacquered) heat sink.
 100cm² x 2mm Al (not lacquered)
 heat sink
 25cm² x 2mm Al (not lacquered)
 heat sink
 Without heat sink (a) (b)
- (c)
- (d)

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